

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









General Description

The MAX1501 intelligent, constant-current, constantvoltage (CCCV), temperature-regulated battery charger charges a single lithium-ion (Li+) cell or three-cell NiMH/NiCd batteries. The device integrates the currentsense resistor, PMOS pass element, and thermalregulation circuitry, while eliminating the reverseblocking Schottky diode to create the simplest charging solution for hand-held equipment.

The MAX1501 functions as a stand-alone charger to control the charging sequence from the pregualification state through fast charge, top-off, and charge termination for single-cell Li+ or three-cell NiMH/NiCd batteries. Alternatively, the MAX1501 collaborates with a host microprocessor to determine the best charging algorithm. Proprietary thermal-regulation circuitry limits the die temperature when fast charging or while exposed to high ambient temperatures, allowing maximum charging current without damaging the charger. The MAX1501 continually supplies a regulated output voltage under no-battery conditions, allowing battery changing.

The device achieves high flexibility by providing an adjustable fast-charge current, top-off current, safety timer (disabled in the MAX1501Z), and thermal-regulation setpoint. Other features include input power detection (ACOK) and input under-/overvoltage protection. The MAX1501 provides active-low control inputs.

The MAX1501 accepts a 4.5V to 13V supply, but disables charging when the input voltage exceeds 6.5V, preventing excessive power dissipation. The MAX1501 operates over the extended temperature range (-40°C to +85°C) and is available in a compact 16-pin thermally enhanced 5mm x 5mm thin QFN package with 0.8mm profile.

Applications

Cellular and Cordless Phones

PDAs

Digital Cameras and MP3 Players

USB Appliances

Charging Cradles and Docks

Bluetooth™ Equipment

Pin Configuration appears at end of data sheet.

Bluetooth is a trademark of Ericsson.

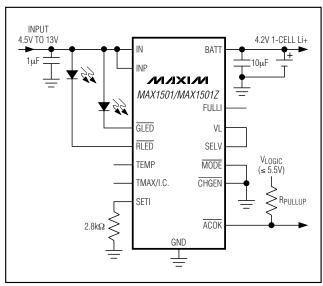
Features

- ♦ Stand-Alone or Microprocessor-Controlled (µP) Linear 1-Cell Li+ or 3-Cell NiMH/NiCd Battery Charger
- **♦** No FET, Reverse-Blocking Diode, or Current-Sense Resistor Required
- ♦ 1.4A (max) Programmable Fast-Charge Current
- +95°C, +115°C, and +135°C Proprietary **Programmable Die Temperature Regulation**
- ♦ 4.5V to 13V Input Voltage Range with Input Overvoltage (OVLO) Protection Above 6.5V
- ♦ Programmable Top-Off Current Threshold: 10%, 20%, or 30% of the Fast-Charge Current
- ♦ Charge-Current Monitor for Fuel Gauging
- **♦** Programmable Safety Timer (3, 4.5, or 6 hours)
- ♦ Input Power Detection Output (ACOK) and Charge **Enable Input (CHGEN)**
- ♦ Automatic Recharge
- **♦ Digital Soft-Start Limits Inrush Current**
- ♦ Charge Status Outputs for LEDs or μP Interface

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX1501ETE	-40°C to +85°C	16 Thin QFN
MAX1501ZETE	-40°C to +85°C	16 Thin QFN

Typical Operating Circuit



NIXIN

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

IN, INP, RLED, GLED to GND	0.3V to +14V
IN to INP	
VL, BATT, SETI, ACOK, MODE, CHGEN, SELV	,
FULLI, TMAX/I.C., TEMP to GND	0.3V to +6V
VL to IN	14V to +0.3V

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
16-Pin 5mm x 5mm Thin QFN	
(derate 21.3mW/°C above +70°C)	1702mW
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = V_{INP} = 5V, V_{BATT} = 3.5V, \overline{ACOK} = \overline{GLED} = \overline{RLED} = TEMP = TMAX/I.C. = FULLI = open, \overline{CHGEN} = \overline{MODE} = GND, R_{SETI} = 2.8k\Omega$, $C_{IN} = 1\mu F$, $C_{BATT} = 10\mu F$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.)

PARAMETER	CONDIT	TIONS	MIN	TYP	MAX	UNITS
IN, INP Input Voltage			0		13	V
IN, INP Input Operating Range			4.50		6.25	V
VL Output Voltage	4.5V ≤ V _{IN} ≤ 6.25V, I _{VL} < 250 _L	ıΑ	2.7	3	3.3	V
	V _{IN} - V _{BATT} , rising		40	70	100	
ACOK Trip Point	V _{IN} - V _{BATT} , falling		30	55	85	mV
	V _{IN} - V _{BATT} , hysteresis			15		
ACOK Sink Current	$4.5V \le V_{IN} \le 6.25V$, $V_{\overline{ACOK}} = 0$	0.6V	75			μΑ
	V _{IN} rising		4.05	4.125	4.20	V
Undervoltage Lockout Trip Point	V _{IN} falling		3.9	4.025	4.1	V
	Hysteresis			100		mV
Overvoltage Lockout Trip Point	V _{IN} rising		6.25	6.50	6.75	V
	Li+, NiMH/NiCd, and no-batte	ry modes		5	8	
IN Input Current	Disable mode			1.5	3	mA
	Off mode $(V_{IN} = 4V)$				0.25	
	$V_{BATT} = 4.3V$			45	80	
BATT Input Current	$V_{IN} = 0$			3	10	μΑ
	Disable mode			2	6	
Leakage into Battery	$V_{IN} = V_{INP} = 13V$, $V_{BATT} = 0$	Disable mode			5	μΑ
RMS Charge Current					1.4	А
	Li+ mode	SELV = VL	4.166	4.2	4.234	
	Li+ mode	SELV = GND	4.067	4.1	4.133]
Battery Regulation Voltage	NiMH/NiCd mode	SELV = VL, V _{IN} = V _{INP} = 6V	4.85	4.95	5.05	V
		SELV = GND	4.4	4.5	4.6]
Output Regulation Voltage	No-battery mode	<u> </u>	3.700	4.0	4.234	V
BATT Precharge Threshold Voltage	BATT rising		2.675	2.8	2.925	V
Fast-Charge Current-Loop	$R_{SETI} = 2.8k\Omega$		460	500	540	A
System Accuracy	$R_{SETI} = 1.75 \text{ k}\Omega$		736	800	864	mA

______NIXIN

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = V_{INP} = 5V, V_{BATT} = 3.5V, \overline{ACOK} = \overline{GLED} = \overline{RLED} = TEMP = TMAX/I.C. = FULLI = open, \overline{CHGEN} = \overline{MODE} = GND, R_{SETI} = 2.8k\Omega, C_{IN} = 1\mu F, C_{BATT} = 10\mu F, T_A = 0^{\circ}C$ to +85°C, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.)

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNITS
Precharge Current System Accuracy	% of fast-charge	current, V _{BATT} = 2V	5	10	15	%
B: T	TEMP = GND			95		
Die Temperature Regulation Setpoint (Note 1)	TEMP = open			115		°C
Setpoint (Note 1)	TEMP = VL			135]
Current Conce Amplifier Coin	IBATT to ISETI, pre	charge mode, V _{BATT} = 2V	0.70	1	1.30	mA/A
Current-Sense Amplifier Gain	IBATT to ISETI, fast	-charge mode	0.95	1	1.05	TIIA/A
Internal Current-Sense Resistance				84		mΩ
Regulator Dropout Voltage	V _{IN} - V _{BATT} , NiMH I _{BATT} = 425mA	H/NiCd mode, V _{BATT} = 4.3V,		190	350	mV
Logic Input Low Voltage	CHGEN, MODE, 4	4.5V ≤ V _{IN} ≤ 6.25V			0.52	V
Logic Input High Voltage	CHGEN, MODE, 4	4.5V ≤ V _{IN} ≤ 6.25V	1.25			V
Internal Pulldown Resistance	CHGEN, MODE		100	175	400	kΩ
Internal Pullup Resistance	SELV		100	175	400	kΩ
Internal Bias Resistance	FULLI, TEMP, TM	AX	50	90	200	kΩ
Internal Bias Voltage	FULLI, TEMP, TM	AX		V _{VL} /2		V
RLED Output Low Current	V _{RLED} = 1V		7	10	18	mA
GLED Output Low Current	$V_{\overline{GLED}} = 1V$		14	20	34	mA
GLED, RLED Output High Leakage Current	VGLED = VRLED =	$V_{IN} = V_{INP} = 13V$		0.1	1	μА
_		FULLI = GND	5	10	15	
Full-Battery Detection Current Threshold	% of fast-charge current	FULLI = VL	15	20	25	%
THESHOLD	Current	FULLI = open	25	30	35	
	I i a secondo	SELV = VL	3.9	4.0	4.1	
V _{BATT} Restart Threshold	Li+ mode	SELV = GND	3.8	3.9	4.0	V
	NiMH/NiCd mode		3.9	4.0	4.1	
Charge-Timer Accuracy			-10		+10	%
Observa Timora Dometica	TMAX = GND			3		
Charge-Timer Duration (MAX1501 Only)	TMAX = open			4.5		hrs
(www.tiooronny)	TMAX = VL			6		

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = V_{INP} = 5V, V_{BATT} = 3.5V, \overline{ACOK} = \overline{GLED} = \overline{RLED} = TEMP = TMAX/I.C. = FULLI = open, \overline{CHGEN} = \overline{MODE} = GND, R_{SETI} = 2.8k\Omega, C_{IN} = 1\mu F, C_{BATT} = 10\mu F, \textbf{T_A} = -40^{\circ}\textbf{C} \text{ to } +85^{\circ}\textbf{C}, unless otherwise noted. Typical values are at T_{A} = +25^{\circ}\textbf{C}.) (Note 2)$

PARAMETER	CONDIT	IONS	MIN	TYP M	ΔX	UNITS
IN, INP Input Voltage			0	1	3	V
IN, INP Input Operating Range			4.50	6.	25	V
VL Output Voltage	$4.5V \le V_{IN} \le 6.25V$, $I_{VL} < 250\mu$	A	2.7	3	.3	V
ACOV Trip Doint	V _{IN} - V _{BATT} , rising		40	10	00	, van / /
ACOK Trip Point	V _{IN} - V _{BATT} , falling	30	8	5	mV	
ACOK Sink Current	4.5V ≤ V _{IN} ≤ 6.25V, V ACOK = 0	.6V	75			μΑ
Lindoweltowal advant Trip Daint	V _{IN} rising		4.00	4.	25	V
Undervoltage Lockout Trip Point	V _{IN} falling		3.90	4.	15	V
Overvoltage Lockout Trip Point			6.25	6.	75	V
IN land Course	Li+, NiMH/NiCd, and no-batter	y modes		8	3	Λ
IN Input Current	Disable mode			(3	mA
	VBATT = 4.3V			8	0	
BATT Input Current	V _{IN} = 0			1	0	μΑ
	Disable mode			(3	
Leakage into Battery	V _{IN} = V _{INP} = 13V, V _{BATT} = 0	Disable mode		ļ	5	μΑ
RMS Charge Current		•		1	.4	А
	Li+ mode	SELV = VL	4.148	4.2	252	
Potton, Population Valtage	LI+ Mode	SELV = GND	4.05	4.	15	V
Battery Regulation Voltage	NiMH/NiCd mode	SELV = VL	4.85	5.	05	V
	Milvin/Mica Mode	SELV = GND	4.4	4	.6	
Output Regulation Voltage	No-battery mode		3.700	4.2	234	V
BATT Precharge Threshold Voltage	BATT rising		2.675	2.9	925	V
Fast-Charge Current-Loop	$R_{SETI} = 2.8k\Omega$		460	54	40	
System Accuracy	$R_{SETI} = 1.75 k\Omega$		736	80	64	mA
Precharge Current System Accuracy	% of fast-charge current, VBAT	T = 2V	5	1	5	%
	IBATT to ISETI, precharge mode	e, V _{BATT} = 2V	0.60	1.	40	
Current-Sense Amplifier Gain	IBATT to ISETI, fast-charge mod		0.93	1.	07	mA/A
Regulator Dropout Voltage	V _{IN} - V _{BATT} , NiMH/NiCd mode I _{BATT} = 425mA	, V _{BATT} = 4.3V,		3	50	mV
Logic Input Low Voltage	CHGEN, MODE, 4.5V < VIN <	6.25V		0.	52	V
Logic Input High Voltage	CHGEN, MODE, 4.5V < VIN <	6.25V	1.3			V
Internal Pulldown Resistance	CHGEN, MODE		100	40	00	kΩ
Internal Pullup Resistance	SELV		100	40	00	kΩ

* _____ /N/X/N

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = V_{INP} = 5V, V_{BATT} = 3.5V, \overline{ACOK} = \overline{GLED} = \overline{RLED} = TEMP = TMAX/I.C. = FULLI = open, \overline{CHGEN} = \overline{MODE} = GND, R_{SETI} = 2.8k\Omega$, $C_{IN} = 1\mu F$, $C_{BATT} = 10\mu F$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 2)

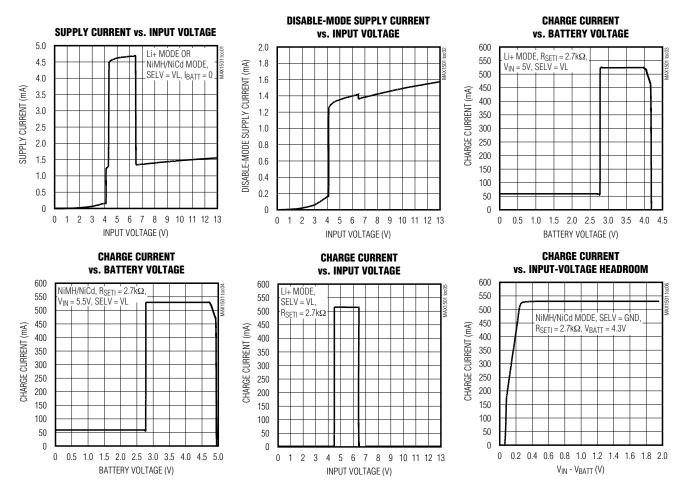
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
RLED Output Low Current	V _{RLED} = 1V	7		18	mA
GLED Output Low Current	VGLED = 1V	14		34	mA
GLED, RLED Output High Leakage Current	VGLED = VRLED = VIN = VINP = 13V			1	μΑ
Charge-Timer Accuracy (MAX1501 Only)		-10		+10	%

Note 1: Temperature regulation setpoint variation is typically ±9°C.

Note 2: Specifications to T_A = -40°C are guaranteed by design, not production tested.

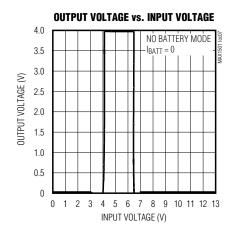
Typical Operating Characteristics

 $(V_{IN} = V_{INP} = 5V, \overline{ACOK} = \overline{RLED} = \overline{GLED} = TEMP = TMAX/I.C. = FULLI = open, C_{BATT} = 10\mu F, C_{IN} = 1\mu F, T_A = +25^{\circ}C, unless otherwise noted.)$

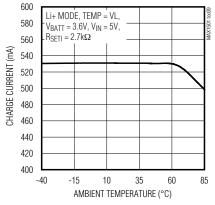


Typical Operating Characteristics (continued)

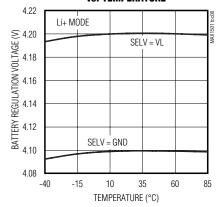
 $(V_{IN} = V_{INP} = 5V, \overline{ACOK} = \overline{RLED} = \overline{GLED} = TEMP = TMAX/I.C. = FULLI = open, C_{BATT} = 10\mu F, C_{IN} = 1\mu F, T_A = +25^{\circ}C, unless otherwise noted.)$



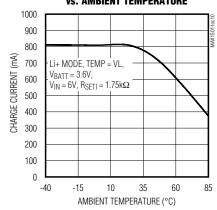




BATTERY REGULATION VOLTAGE vs. TEMPERATURE



CHARGE CURRENT vs. AMBIENT TEMPERATURE



Pin Description

PIN	NAME	FUNCTION
1	INP	High-Current Charger Input. Connect an AC adapter to INP and IN as close to the device as possible. INP provides charge current to the battery. INP draws current while the device is in shutdown mode.
2	IN	Low-Current Charger Input. Bypass IN to GND with a 1µF ceramic capacitor. Connect IN to INP as close to the device as possible. IN powers the internal LDO and reference. IN draws current while the device is in shutdown mode.
3, 13	GND	Ground. Connect the exposed paddle to GND.
4	SETI	Current-Sense Transconductance Amplifier Output. Connect a resistor from SETI to GND to program the maximum charge current and to monitor the actual charge current. SETI pulls to GND during shutdown.
5	VL	Linear Regulator Output. Connect CHGEN, TEMP, TMAX, FULLI, and MODE to VL to program logic high. VL discharges to GND during shutdown.
6	TMAX	Maximum Charging-Time Select Input (MAX1501 Only). TMAX sets the maximum charging time. Connect TMAX to GND to set the maximum charging time to 3 hours. Leave TMAX floating to set the maximum charging time to 4.5 hours. Connect TMAX to VL to set the maximum charging time to 6 hours. TMAX pulls to GND through a $50k\Omega$ resistor in shutdown.
	I.C.	Internally Connected in the MAX1501Z. Leave floating.
7	FULLI	Top-Off-Current Select Input. FULLI sets the end-of-charge threshold as a percentage of the fast-charge current. Connect FULLI to GND to set the end-of-charge threshold to 10% of the fast-charge current. Connect FULLI to VL to set the end-of-charge threshold to 20% of the fast-charge current. Leave FULLI floating to set the end-of-charge threshold to 30% of the fast-charge current. FULLI pulls to GND through a $50k\Omega$ resistor in shutdown.
8	TEMP	Die Temperature Select Input. TEMP sets the die temperature regulation point for the thermal-control loop. Connect TEMP to GND to regulate the die temperature at $+95^{\circ}$ C. Leave TEMP floating to regulate the die temperature at $+115^{\circ}$ C. Connect TEMP to VL to regulate the die temperature at $+135^{\circ}$ C. TEMP pulls to GND through a $50k\Omega$ resistor in shutdown.
9	MODE	Mode Select Input. MODE and CHGEN together control charging functions (Table 1). An internal 175kΩ pulldown resistor pulls MODE low.
10	CHGEN	Charge Enable Input. CHGEN and MODE together control charging functions (Table 1). An internal 175kΩ pulldown resistor pulls CHGEN low.
11	ACOK	Input Voltage Range Indicator. The open-drain \overline{ACOK} output asserts low when $4.2V \le V_{IN} \le 6.25V$ and $V_{IN} - V_{BATT} \ge 100 \text{mV}$. \overline{ACOK} requires an external $100 \text{k}\Omega$ pullup resistor. \overline{ACOK} floats in shutdown.
12	BATT	Battery Connection. Connect the positive terminal of the battery to BATT. BATT draws less than 5µA during shutdown.
14	SELV	Battery Voltage Selection Input. SELV sets the battery regulation voltage in Li+ and NiMH/NiCd modes (Table 2). For no-battery mode, the battery voltage defaults to 4.0V. An internal $175 \text{k}\Omega$ resistor to VL pulls SELV high.
15	RLED	Battery Charging Indicator. Connect the anode of a red LED to IN and the cathode to $\overline{\text{RLED}}$. $\overline{\text{RLED}}$ asserts low when the input supply is present and the battery is charging, regardless of cell chemistry. $\overline{\text{RLED}}$ sinks 10mA. $\overline{\text{RLED}}$ goes high impedance in shutdown. Connect a pullup resistor to the μP 's I/O supply when interfacing with a μP logic input.
16	GLED	Full-Charge Indicator. Connect the anode of a green LED to IN and the cathode to $\overline{\text{GLED}}$. $\overline{\text{GLED}}$ asserts low when the input supply is present and the battery has reached the top-off current threshold set by FULLI, regardless of cell chemistry. $\overline{\text{GLED}}$ sinks 20mA. $\overline{\text{GLED}}$ goes high impedance in shutdown. Connect a pullup resistor to the $\mu\text{P's}$ I/O supply when interfacing with a μP logic input.

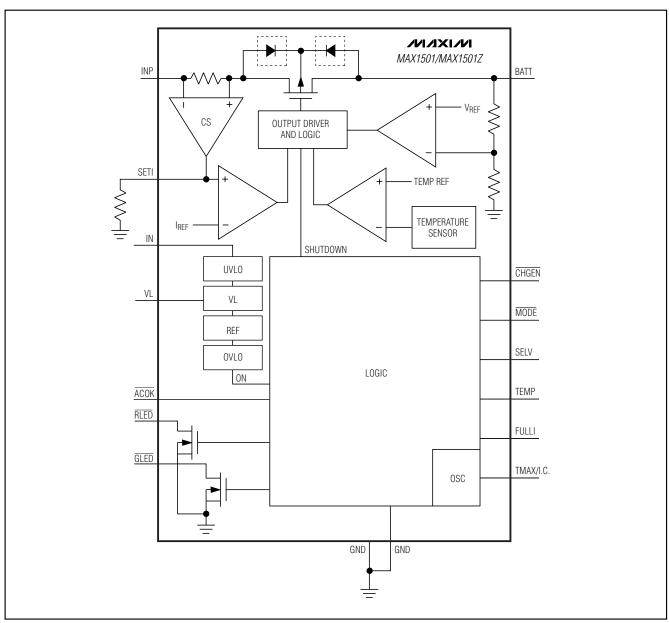


Figure 1. Functional Diagram

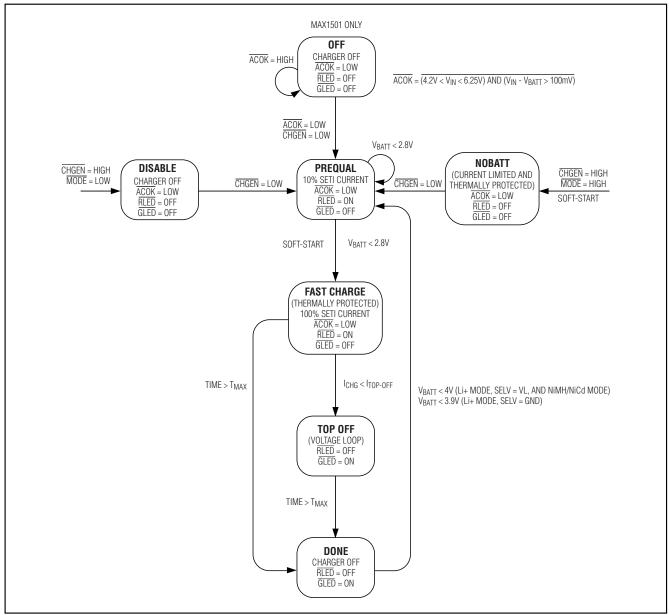


Figure 2. MAX1501 Charge State Diagram

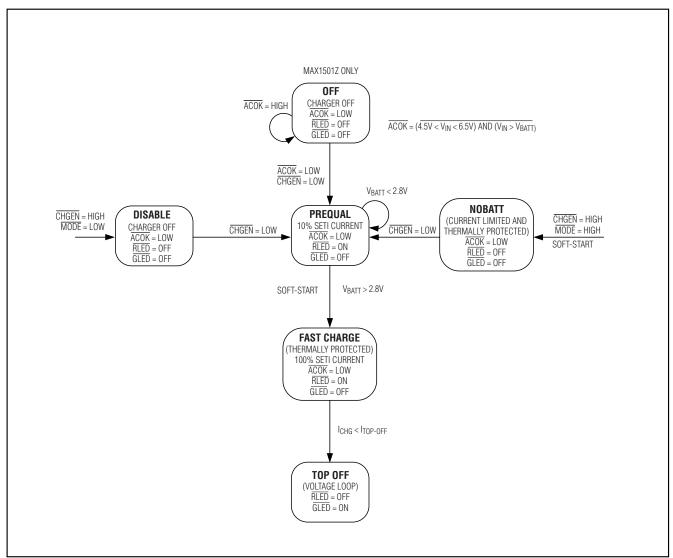


Figure 3. MAX1501Z Charge State Diagram

Detailed Description

Modes of Operation

 $\overline{\text{CHGEN}}$ and $\overline{\text{MODE}}$ together set the operating modes of the MAX1501. Both inputs possess internal 175kΩ pulldown resistors to GND. Table 1 describes the four operating modes of the MAX1501.

Table 1. Modes of Operation

MODE	CHGEN	MODE
Li+ Charge Mode	0	0
NiMH/NiCd Charge Mode	0	1
Disable Mode	1	0
No-Battery Mode	1	1

Table 2. Battery Regulation Voltage

CHARGING MODE	SE	LV
CHARGING MODE	GND	VL
Li+	4.1V	4.2V
NiMH/NiCd	4.5V	4.95V

Li+ Charge Mode

Connect CHGEN and MODE to GND to place the MAX1501 in Li+ charging mode. The Li+ charger consists of a voltage-control loop, a current-control loop, and a thermal-control loop. Connect SELV to GND to set the Li+ battery voltage to 4.1V. Connect SELV to VL to set the Li+ battery voltage to 4.2V (Table 2).

The MAX1501 precharges the Li+ battery with 10% of the user-programmed fast-charge current at the start of a charge cycle. A soft-start algorithm ramps up the charging current (10% steps with 20ms duration per step) to the fast-charge current when the battery voltage reaches 2.8V. The MAX1501 enters constant-voltage mode and decreases the charge current when the BATT voltage reaches the selected regulation voltage (4.1V or 4.2V). Set the fast-charge current with a resistor between SETI and GND (see the *Charge-Current Selection* section).

The thermal-regulation loop limits the MAX1501 die temperature to the value selected by the TEMP input by reducing the charge current as necessary (see the *Thermal-Regulation Selection* section). This feature not only protects the MAX1501 from overheating, but also allows the charge current to be set higher without risking damage to the system.

Set the top-off-current threshold with the three-state FULLI input (see the *Top-Off-Current Selection* section). RLED goes high impedance and GLED asserts low when the top-off-current threshold is reached. The MAX1501 automatically initiates recharging when the battery voltage drops below 95% of the voltage set by SELV. (The MAX1501Z does not time out.)

NiMH/NiCd Charge Mode

Connect $\overline{\text{CHGEN}}$ to GND and $\overline{\text{MODE}}$ to VL to place the MAX1501 in NiMH/NiCd charging mode. The NiMH/NiCd battery charger consists of a current-control loop, a voltage-control loop, and a thermal-control loop. Connect SELV to GND to set the regulation voltage to 4.5V. Connect SELV to VL to set the regulation voltage to 4.95V (Table 2). When charging three NiMH/NiCd cells to 4.95V, VIN must be at least 5.25V and a μP must be used to terminate the charge sequence.

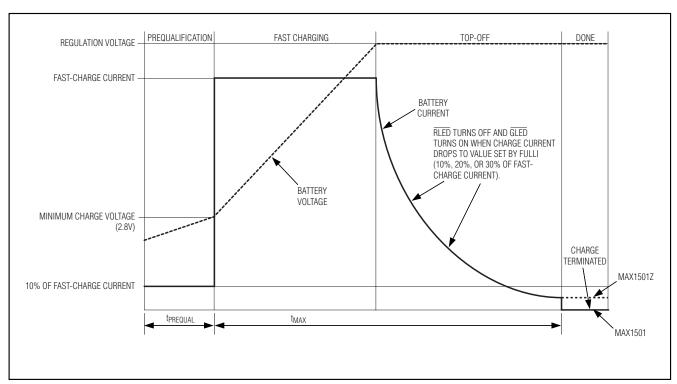


Figure 4. Li+ Charge Sequence

Table 3. RLED and GLED Behavior

MODE	STATE	RLED	GLED
Li+ Mode or NiMH/NiCd Mode	 10% current-limited precharge Current-limited charge Voltage-limited charge before top-off Temperature-limited charge before top-off 	Sinks 10mA	High impedance
	Voltage-limited charge after top-offSafety timer expires (MAX1501 only)	High impedance	Sinks 20mA
Disable Mode	_	High impedance	High impedance
No Battery Mode	_	High impedance	High impedance

The MAX1501 precharges the NiMH/NiCd battery with 10% of the user-programmed fast-charge current at the start of a charge cycle. Precharge ends and fast charge begins when the battery voltage exceeds 2.8V. Set the fast-charge current with a resistor between SETI and GND (see the *Charge-Current Selection* section). The MAX1501 enters constant-voltage mode and decreases the charge current when the battery voltage reaches 4.5V.

The thermal-regulation loop limits the MAX1501 die temperature to the value selected by the TEMP input by reducing the charge current as necessary (see the *Thermal-Regulation Selection* section). This feature protects the MAX1501 from overheating when supplying high charge currents, or while operating from high input voltages.

Set the top-off-current threshold with the three-state <u>FULLI</u> input (see the *Top-Off-Current Selection* section). <u>RLED</u> goes high impedance and <u>GLED</u> asserts low when the top-off current threshold is reached. The MAX1501 automatically initiates recharging when the battery voltage drops below 4V. (The MAX1501Z does not time out.)

No-Battery Mode

Connect $\overline{\text{CHGEN}}$ and $\overline{\text{MODE}}$ to VL to place the MAX1501 in no-battery mode. An external load can be connected to BATT in this mode. V_{BATT} regulates to 4V in no-battery mode, regardless of the state of SELV.

The current-control loop, voltage-control loop, and thermal-control loop all function in no-battery mode. The loop gain of the voltage-control loop decreases to ensure stability with no battery present. Connect a 10µF ceramic capacitor to BATT for stability. RLED and GLED are both high impedance in no-battery mode.

ACOK

The \overline{ACOK} output asserts low when V_{IN} is present, 4.2V \leq V_{IN} \leq 6.25V, and V_{IN} - V_{BATT} > 100mV. The \overline{ACOK} open-drain output requires an external 100k Ω pullup

resistor to an external supply voltage. The external supply voltage must be less than 5.5V.

RLED and GLED Indicators

RLED and $\overline{\text{GLED}}$ serve as visual indicators that power is applied as well as the charge status of a battery. RLED asserts low when a wall adapter is connected and a battery is charging, regardless of cell chemistry. $\overline{\text{GLED}}$ asserts low when power is applied and the battery is fully charged. Both outputs go high-impedance in shutdown. Connect the anode of each LED to IN, and the cathode to $\overline{\text{RLED}}$ or $\overline{\text{GLED}}$. Table 3 summarizes the behavior of $\overline{\text{RLED}}$ and $\overline{\text{GLED}}$ under normal operating conditions. Connect pullup resistors to the μP I/O supply when interfacing $\overline{\text{RLED}}$ and $\overline{\text{GLED}}$ with a μP 's logic inputs.

Soft-Start

A ten-step, soft-start algorithm activates when entering fast-charge mode. The charging current ramps up in 10% increments, 20ms per step, to the full charging current when VBATT exceeds 2.8V.

Applications Information

Charge-Current Selection

Program the charging current using an external resistor between SETI and GND. Set the charge-current resistor with the following equation:

$$R_{SETI} = 1000 \times \frac{1.4V}{I_{BATT}}$$

If V_{SETI} = 1.4V, the current-control loop controls the battery charging. If V_{SETI} < 1.4V, either the voltage-control loop or the thermal-control loop operates. Measure the charging current by monitoring V_{SETI} and using the following equation:

$$V_{SETI} = \frac{I_{BATT}}{1000} \times R_{SETI}$$

12 ______ **MAXI**

Thermal-Regulation Selection

Set the regulated die temperature of the MAX1501 with the TEMP three-level logic input. The MAX1501 reduces the charge current to limit the die temperature to the value set by TEMP. The MAX1501 operates normally while the thermal loop is active. An active thermal loop does not indicate a fault condition. TEMP allows the MAX1501 to maximize the charge current while providing protection against excessive power dissipation.

Connect TEMP to GND to regulate the die temperature at +95°C. Leave TEMP floating to regulate the die temperature at +115°C. Connect TEMP to VL to regulate the die temperature at +135°C.

Top-Off-Current Selection

Set the top-off-current threshold in the Li+ and NiMH/NiCd charge modes with the FULLI three-level logic input. The top-off-current threshold determines when RLED turns off and GLED turns on, indicating the charge status of the battery.

Connect FULLI to GND to set the top-off-current threshold to 10% of the fast-charge current. Connect FULLI to VL to set the top-off-current threshold to 20% of the fast-charge current. Leave FULLI floating to set the top-off-current threshold to 30% of the fast-charge current.

Charge-Timer Selection (MAX1501 Only)

Set the maximum charging time with the TMAX three-level logic input. TMAX limits the duration of charging to protect the battery from overcharging. Connect TMAX to GND to set the maximum charging time to 3 hours. Leave TMAX floating to set the maximum charging time

4.5V TO 6.5V 4 2V 1-CFI LIi+ RATI ADAPTER 1µF MIXIM MAX1501/MAX1501Z GI FD MODE RLED TMAX/I.C ACOK TFMP SELV FULLI SETI GND

Figure 5. Stand-Alone Li+ Battery Charger

to 4.5 hours. Connect TMAX to VL to set the maximum charging time to 6 hours.

Capacitor Selection

Connect a ceramic capacitor from BATT to GND for proper stability. Use a 10µF X5R ceramic capacitor for most applications.

Connect IN and INP together and bypass to GND with a 1µF ceramic capacitor. Use a larger input bypass capacitor for high input voltages or high charging currents to reduce supply noise.

Thermal Considerations

The MAX1501 is available in a thermally enhanced thin QFN package with exposed paddle. Connect the exposed paddle of the MAX1501 to a large copper ground plane to provide a thermal contact between the device and the circuit board. The exposed paddle transfers heat away from the device, allowing the MAX1501 to charge the battery with maximum current, while minimizing the increase in die temperature.

Application Circuits

Figure 5 shows the MAX1501 as a stand-alone Li+ battery charger. The $2.8k\Omega$ resistor connected to SETI sets a charging current of 500mA.

Figure 6 shows the MAX1501 as a $\mu\text{P-based Li+}$ battery charger. Drive $\overline{\text{CHGEN}}$ low to charge the battery. Drive $\overline{\text{CHGEN}}$ high to disable the charger. Connect a $100\text{k}\Omega$ pullup resistor from $\overline{\text{ACOK}}$ to the logic supply voltage of the μP to detect the presence of an input supply. The logic supply voltage must be less than 5.5V.

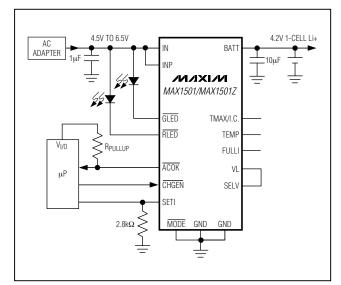


Figure 6. μP-Based Li+ Battery Charger

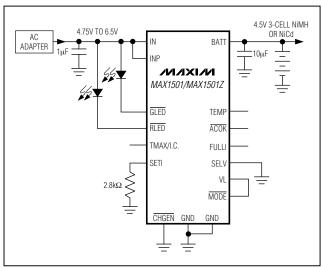


Figure 7. Stand-Alone 3-Cell NiMH or NiCd Battery Charger

Figure 7 shows the MAX1501 as a stand-alone NiMH/NiCd battery charger. Connecting SELV to GND sets the charge termination voltage to 4.5V.

Figure 8 shows the MAX1501 as a μP -based NiMH/NiCd battery charger. Connecting SELV to VL sets the charge regulation voltage at 4.95V. Connect a $100k\Omega$ pullup resistor from \overline{ACOK} to the logic supply voltage of the μP . The logic supply voltage must be less than 5.5V.

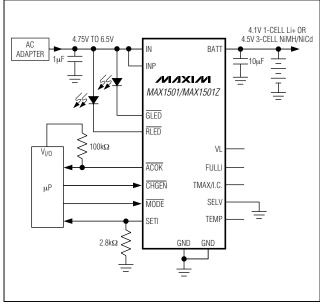


Figure 9. µP-Based Single Li+/3-Cell NiMH/NiCd Battery Charger

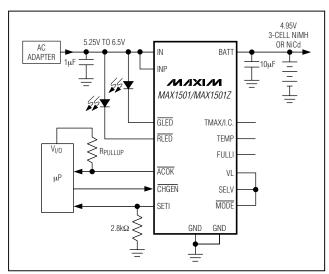


Figure 8. μP-Based NiMH or NiCd Battery Charge

Figure 9 shows the MAX1501 as a μ P-based single Li+ or 3-cell NiMH/NiCd charger. The states of $\overline{\text{MODE}}$ and $\overline{\text{CHGEN}}$ set the operating mode of the MAX1501 (Table 1). Connect a $100\text{k}\Omega$ pullup resistor from $\overline{\text{ACOK}}$ to the logic supply voltage of the μ P. The logic supply voltage must be less than 5.5V.

Figure 10 shows the MAX1501 as an accurate current-limited low-dropout linear regulator with input overvoltage protection (no-battery mode). The output voltage regulates to 4V, regardless of the state of SELV. Connect $\overline{\text{MODE}}$ to VL to enable the linear regulator. Connect $\overline{\text{MODE}}$ to GND to put the device into shutdown. RSETI sets the maximum output current.

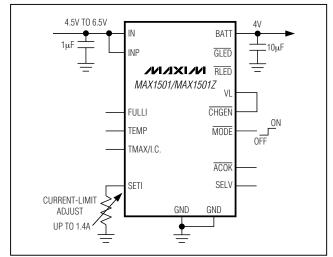


Figure 10. Input Overvoltage-Protected and Current-Limited Low-Dropout Linear Regulator

14 ______ **////XI///**

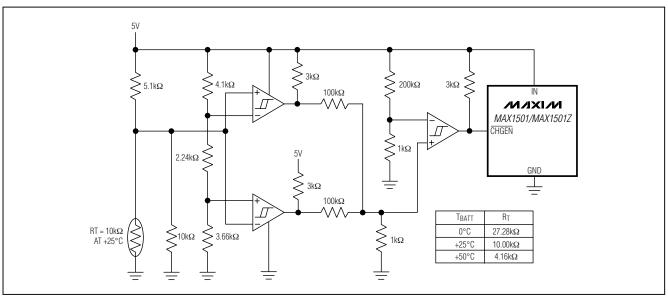


Figure 11. Battery Temperature Protection

Figure 11 shows a circuit that adds temperature protection to the battery. Install the thermistor as close to the battery as possible to ensure accurate temperature measurement. The output of this circuit is logic high when the battery temperature is less than 0°C and greater than +50°C. Driving CHGEN high disables the charger.

Layout and Bypassing

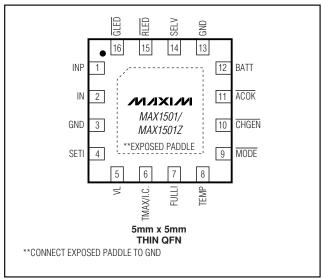
Connect IN and INP together as close to the device as possible and bypass with a $1\mu F$ ceramic capacitor. Bypass BATT to GND with a $10\mu F$ ceramic capacitor.

Provide a large copper GND plane to allow the exposed paddle to sink heat away from the device. Connect the battery to BATT as close to the device as possible to provide the most accurate battery voltage sensing. Make all high-current traces short and wide to minimize voltage drops.

Chip Information

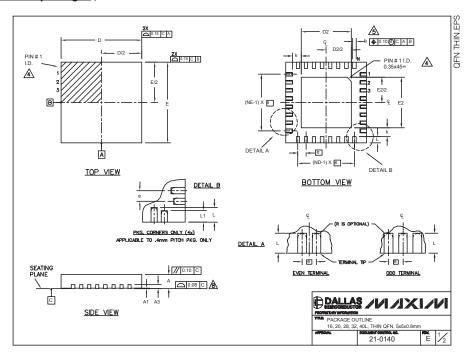
TRANSISTOR COUNT: 5717
PROCESS: BICMOS

Pin Configuration



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



					С	OMM	ON D	IMEN	SIONS	3									EXF	OSED	PAD	VARIA	TIONS	3			
PKG.	1	6L 5x	5	2	:0L 5x	5	2	28L 5x	:5	3	2L 5x	ι5	4	40L 5x5		40L 5x5		1	PK	(G		D2			E2		DOWN
YMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		CO	DDES	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	BONDS ALLOWED		
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	5	T1	655-1	3.00	3.10	3.20	3.00	3.10	3.20	NO		
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	-	0.05	5	T1	655-2	3.00	3.10	3.20	3.00	3.10	3.20	YES		
A3	0.	20 RE	F.	0.	20 RE	F.	0.	20 RE	F.	0.	20 RE	F.	0.:	20 RE	F.	1	_	055-2	3.00	3.10	3.20	3.00	3.10	3.20	NO		
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25	5	1	055-3	3.00	3.10	3.20	3.00	3.10	3.20	YES		
D	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	5		055-4	3.00	3.10	3.20	3.00	3.10	3.20	NO		
Е	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	5		855-1	3.15	3.25	3.35	3.15	3.25	3.35	NO		
е	0	80 BS	SC.	0	.65 BS	C.	0	.50 BS	SC.	0	.50 BS	SC.	0.	40 B	SC.	1		855-2	2.60	2.70	2.80	2.60	2.70	2.80	NO		
k	0.25	-	-	0.25	-		0.25	-	-	0.25	-	-	0.25	0.35	0.45	5	_	855-3	3.15	3.25	3.35	3.15	3.25	3.35	YES		
L	0.30	0.40	0.50	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.40	0.50	_	_		855-4	2.60	2.70	2.80	2.60	2.70	2.80	NO.		
L1	-	-	-	-	-	-	-	-	-	-	-	-	0.30	0.40	0.50	5		855-5 855-6	2.60	2.70 3.25	2.80	2.60	2.70 3.25	2.80	NO NO		
N		16		\vdash	20	_	-	28		-	32		_	40		Η		855-7	2.60	2.70	2.80	2.60	2.70	2.80	YES		
ND		4			5			7			8			10		1		255-2	3.00	3.10	3.20	3.00	3.10	3.20	NO		
NE		4			5		$\overline{}$	7		\vdash	8			10		┪.	Ta	255-3	3.00	3.10	3.20	3.00	3.10	3.20	YES		
IEDEC	١	NHHE					_			_																	
		/VI II IL	<u> </u>		WHHC	;	\	VHHD	-1	V	VHHD.	-2		-		1	T3:	255-4 055-1	3.00 3.20	3.10 3.30	3.20 3.40	3.00	3.10	3.20 3.40	NO YES		
ZOI	DIMEN THE T TERM 2-012. NE IND	NING & ISIONS TOTAL IINAL # DETAII	TOLES ARE INUMBI	RANCI IN MILL ER OF ITIFIEF TERMII TERM	ING CO LIMETE TERMII R AND 1 NAL #1 INAL #1	NFORI RS. AN NALS. FERMIN IDENT	M TO A	ASME II ARE II JMBER ARE O MAY E	/14.5M N DEG IING C PTION BE EITI	I-1994. REES. ONVEN AL, BU HER A	ITION : T MUS MOLD	SHALL T BE L OR MA	OCATE	D WIT	THIN THURE.	HE	T3: T4i			_			_	-			
1. DIM 2. ALL 3. N IS THE SPF ZOI DIM FRO	DIMEN THE T TERM 2-012. NE IND ENSIO DM TER	NING & SIONS TOTAL IINAL # DETAII ICATEI N b AP	TOLE ATOLE NUMBI TIDEN S OF THE PLIES TIP.	RANCI IN MILLI ER OF ITIFIEF TERMII TERM TO ME	ING CO LIMETE TERMII R AND 1 NAL #1 INAL #1	NFORI RS. AN NALS. FERMIN IDENT I IDENT	M TO AN INTERNATION OF THE PROPERTY OF THE PRO	ASME II ARE II JMBER ARE OI MAY E	(14.5M N DEG RING C PTION BE EITI IS ME	I-1994. REES. ONVEN AL, BU HER A	ITION : T MUS MOLD ED BET	SHALL T BE L OR MA	OCATE RKED 0.25 m	D WIT FEATI	THIN TH URE. D 0.30	HE	T3: T4i			_			_	-			
1. DIM 2. ALL 3. N IS THE SPF ZOI A DIM FRO ND	DIMEN THE 1 TERM P-012. NE IND ENSIO OM TER	NING & ISIONS TOTAL IINAL # DETAII ICATEI N b AP RMINAL	TOLES ARE INUMBI	RANCI IN MILL ER OF ITIFIER TERMI TERM TO ME	ING CO LIMETE TERMII R AND T NAL #1 INAL #1 TALLIZ	NFORI RS. AN NALS. FERMIN IDENT I IDENT	M TO ANGLES NAL NU IFIER TIFIER RMINA	ASME II JMBER ARE OI MAY E	(14.5M N DEG RING C PTION BE EITH IS ME	I-1994. REES. ONVEN AL, BU HER A	ITION : T MUS MOLD ED BET	SHALL T BE L OR MA	OCATE RKED 0.25 m	D WIT FEATI	THIN TH URE. D 0.30	HE	T3: T4i			_			_	-			
1. DIM 2. ALL 3. N IS THE SPF ZOI DIM FRO ND 7. DEF	DIMEN THE 1 TERM P-012. NE IND ENSIO DM TER AND N	NING & ISIONS TOTAL IINAL # DETAII ICATEI N b AP RMINAL E REFE	LA TOLES ARE I NUMBI 1 IDEN LS OF 1 D. THE PLIES TIP. ER TO	ERANCI IN MILLI ER OF ITIFIEF TERMI TERM TO ME	ING CO LIMETE TERMII R AND 1 NAL #1 INAL #1 TALLIZ UMBER IN A S	NFORI RS. AN NALS. FERMIN IDENT I IDENT ED TE	M TO ANGLES NAL NUT IFIER TIFIER RMINA ERMIN	ASME N ARE II JMBER ARE OI MAY E AL AND ALS OI L FASH	/14.5M N DEG LING C PTION BE EITH IS ME IS ME N EACH	I-1994. REES. ONVEN AL, BU HER A ASURE	ITION : T MUS MOLD ED BET D E SII	SHALL T BE L OR MA TWEEN DE RE	OCATE RKED 0.25 m	D WIT FEATU Im AN	THIN TH URE. D 0.30	HE	T3: T4i		3.20	3.30	3.40	3.20	3.30	3.40	YES		
1. DIM 2. ALL 3. N IS THE SPF ZOI A DIM FRO ND	DIMEN THE 1 TERM 2-012. NE IND ENSIO DM TER AND N POPUL	NING & ISIONS TOTAL IINAL # DETAII ICATEI N b AP RMINAL E REFE ATION RITY A	LA TOLE S ARE I NUMBI S OF TO THE PLIES TIP. ER TO IS POSE	RANCI IN MILLI ER OF ITIFIEF TERMI TO ME THE N SSIBLE S TO TI	ING CO LIMETE TERMII R AND T NAL #1 INAL #1 TALLIZ UMBER IN A S' HE EXF	NFORI RS. AN NALS. FERMIN IDENT IDENT ED TE COF TE YMME*	M TO A NGLES NAL NI IFIER TIFIER RMINA FRMINA TRICAL HEAT	ASME Y ARE II JMBER ARE OI MAY E AL AND ALS OI L FASH SINK S	Y14.5M N DEG VID VIDEG VIDEG VIDEG VIDEG VID VIDEG VID VID VID VID	I-1994. REES. ONVEN AL, BU HER A ASURE H D AN	ITION: T MUS MOLD ED BET D E SII	SHALL T BE L OR MA WEEN DE RE	OCATE RKED 0.25 m SPECT	ED WIT FEATI IN AN IVELY	THIN TH URE. D 0.30	HE	T3: T4i		3.20	3.30	3.40 A.S.	3.20	3.30	3.40			

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

______Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600